3.3V ECL ÷2, ÷4, ÷8 Clock Generation Chip

The MC100LVEL34 is a low skew $\div 2$, $\div 4$, $\div 8$ clock generation chip designed explicitly for low skew clock generation applications. The internal dividers are synchronous to each other, therefore, the common output edges are all precisely aligned. The V_{BB} pin, an internally generated voltage supply, is available to this device only. For single–ended input conditions, the unused differential input is connected to V_{BB} as a switching reference voltage. V_{BB} may also rebias AC coupled inputs. When used, decouple V_{BB} and V_{CC} via a 0.01 µF capacitor and limit current sourcing or sinking to 0.5 mA. When not used, V_{BB} should be left open.

The common enable (\overline{EN}) is synchronous so that the internal dividers will only be enabled/disabled when the internal clock is already in the LOW state. This avoids any chance of generating a runt clock pulse on the internal clock when the device is enabled/disabled as can happen with an asynchronous control. An internal runt pulse could lead to losing synchronization between the internal divider stages. The internal enable flip-flop is clocked on the falling edge of the input clock; therefore, all associated specification limits are referenced to the negative edge of the clock input.

Upon start–up, the internal flip-flops will attain a random state; the master reset (MR) input allows for the synchronization of the internal dividers, as well as multiple LVEL34s in a system.

- 50 ps Typical Output-to-Output Skew
- Synchronous Enable/Disable
- Master Reset for Synchronization
- 1.5 GHz Toggle Frequency
- The 100 Series Contains Temperature Compensation.
- PECL Mode Operating Range: $V_{CC} = 3.0 \text{ V}$ to 3.8 V with $V_{EE} = 0 \text{ V}$
- NECL Mode Operating Range: V_{CC} = 0 V with V_{EE} = -3.0 V to -3.8 V
- Open Input Default State
- LVDS Input Compatible



*For additional information, refer to Application Note AND8002/D

ORDERING INFORMATION

Device	Package	Shipping
MC100LVEL34D	SO-16	48 Units/Rail
MC100LVEL34DR2	SO-16	2500 Units/Reel
MC100LVEL34DT	TSSOP-16	96 Units/Rail
MC100LVEL34DTR2	TSSOP-16	2500 Units/Reel



Warning: All V_{CC} and V_{EE} pins must be externally connected to Power Supply to guarantee proper operation.



PIN DESCRIPTION

FUNCTION
ECL Diff Clock Inputs
ECL Sync Enable
ECL Master Reset
ECL Diff ÷2 Outputs
ECL Diff ÷4 Outputs
ECL Diff +8 Outputs
Reference Voltage Output
Positive Supply
Negative Supply
No Connect

* Pins will default LOW when left open.

** Pins will default to $V_{CC}/2$ when left open.

FUNCTION TABLE

CLK	EN	MR	FUNCTION
Z	L	L	Divide
ZZ	н	L	Hold Q ₀₋₃
х	Х	н	Reset Q ₀₋₃

Z = Low-to-High Transition

ZZ = High-to-Low Transition

Charac	Value		
Internal Input Pulldown Resistor		75 kΩ	
Internal Input Pullup Resistor		37.5 kΩ	
ESD Protection	Human Body Model Machine Model Charged Device Model	> 2 kV > 200 V > 2 kV	
Moisture Sensitivity, Indefinite T	ime Out of Drypack (Note 1)	Level 1	
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V–0 @ 0.125 in	
Transistor Count		210 Devices	
Meets or exceeds JEDEC Spec	EIA/JESD78 IC Latchup Test		

ATTRIBUTES

1. For additional Moisture Sensitivity information, refer to Application Note AND8003/D.

MAXIMUM RATINGS (Note 2)

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V _{CC}	PECL Mode Power Supply	V _{EE} = 0 V		6	V
V_{EE}	NECL Mode Power Supply	$V_{CC} = 0 V$		-6	V
VI	PECL Mode Input Voltage NECL Mode Input Voltage	V _{EE} = 0 V V _{CC} = 0 V	$\begin{array}{l} V_{I} \leq V_{CC} \\ V_{I} \geq V_{EE} \end{array}$	6 6	V V
l _{out}	Output Current	Continuous Surge		50 100	mA mA
I _{BB}	V _{BB} Sink/Source			± 0.5	mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 LFPM 500 LFPM	16 SOIC 16 SOIC	100 60	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	std bd	16 SOIC	33 to 36	°C/W
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 LFPM 500 LFPM	16 TSSOP 16 TSSOP	138 108	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	std bd	16 TSSOP	33 to 36	°C/W
T _{sol}	Wave Solder	<2 to 3 sec @ 248°C		265	°C

2. Maximum Ratings are those values beyond which device damage may occur.

				–40°C		25°C			85°C				
Symbol	Characteristic		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit	
I _{EE}	Power Supply Current		40	50	60	40	50	60	42	52	62	mA	
V _{OH}	Output HIGH Voltage (Note 4)		2155	2280	2405	2155	2280	2405	2155	2280	2405	mV	
V _{OL}	Output LOW Voltage (Note 4)		1355	1570	1725	1355	1570	1725	1355	1570	1725	mV	
V _{IH}	Input HIGH Voltage (Single Ended)		2075		2420	2075		2420	2075		2420	mV	
V _{IL}	Input LOW Voltage (Single Ended)		1355		1675	1355		1675	1355		1675	mV	
V_{BB}	Output Voltage Reference		1775	1875	1975	1775	1875	1975	1775	1875	1975	mV	
VIHCMR	Input HIGH Voltage Common Mode Range (Differential) (Note 5)		1.2		3.3	1.2		3.3	1.2		3.3	V	
I _{IH}	Input HIGH Current				150			150			150	μΑ	
IIL	Input LOW Current	D D	0.5 -150			0.5 -150			0.5 -150			μΑ	

100LVEL DC CHARACTERISTICS, PECL V_{CC} = 3.3 V, V_{EE} = 0 V (Note 3)

NOTE: LVEL circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

3. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.925 V to –0.5 V.

4. All loading with 50 Ω to V_{CC} – 2.0 V.

5. VI_{HCMR} min varies 1:1 with V_{EE}, V_{IHCMR} max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

100LVEL DC CHARACTERISTICS, NECL $V_{CC} = 0 V$, $V_{EE} = -3.8 V$ to -3.0 V (Note 6)

		−40°C		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current	40	50	60	40	50	60	42	52	62	mA
V _{OH}	Output HIGH Voltage (Note 7)	-1145	-1020	-895	-1145	-1020	-895	-1145	-1020	-895	mV
V _{OL}	Output LOW Voltage (Note 7)	-1945	-1700	-1575	-1945	-1700	-1575	-1945	-1700	-1575	mV
V _{IH}	Input HIGH Voltage (Single Ended)	-1225		-880	-1225		-880	-1225		-880	mV
V _{IL}	Input LOW Voltage (Single Ended)	-1945		-1625	-1945		-1625	-1945		-1625	mV
V_{BB}	Output Voltage Reference	-1525	-1425	-1325	-1525	-1425	-1325	-1525	-1425	-1325	mV
VIHCMR	Input HIGH Voltage Common Mode Range (Differential) (Note 8)	V _{EE}	+1.2	0.0	V _{EE}	+1.2	0.0	V _{EE}	+1.2	0.0	V
I _{IH}	Input HIGH Current			150			150			150	μΑ
IIL	Input LOW Current D D	0.5 -150			0.5 -150			0.5 -150			μΑ

NOTE: LVEL circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

6. Input and output parameters vary 1:1 with V_{CC}. 7. All loading with 50 Ω to V_{CC} – 2.0 V. 8. V_{IHCMR} min varies 1:1 with V_{EE}, V_{IHCMR} max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

			00									
			−40°C		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit	
f _{max}	Maximum Toggle Frequency (See Figure 4. F _{max} /JITTER)	1.5			1.5			1.5			GHz	
t _{PLH} t _{PHL}	Propagation CLK to Q0, Q1, Q2 Delay to Output MR to Q	550 500	650 600	1000 1000	600 550	700 650	1000 1000	650 600	750 700	1000 1000	ps	
t _{JITTER}	Cycle-to-Cycle Jitter (See Figure 4. F _{max} /JITTER)		< 1			< 1			< 1		ps	
t _S	Setup Time EN	150	50		150	50		150	50		ps	
t _H	Hold Time EN	200	100		200	100		200	100		ps	
t _{RR}	Set/Reset Recovery	300	200		300	200		300	200		ps	
V _{PP}	Input Swing (Note 10)	150		1000	150		1000	150		1000	mV	
t _r t _f	Output Rise/Fall Times Q (20% – 80%)	120	170	400	140	180	400	160	200	400	ps	

AC CHARACTERISTICS V_{CC}= 0 V; V_{EE}= -3.8 V to -3.0 V or V_{CC}= 3.0 V to 3.8 V; V_{EE}= 0 V (Note 9)

9. Measured using a 750 mV source, 50% duty cycle clock source. All loading with 50 Ω to V_{CC} – 2.0 V. 10. V_{PP(}min) is minimum input swing for which AC parameters guaranteed. The device has a DC gain of ~40.





CASE 2: If the MR is de-asserted (H–L), after the Clock has transitioned low, the outputs will follow the third ensuing clock rising edge.

Figure 2. Timing Diagrams

The \overline{EN} signal will "freeze" the internal divider flip–flops on the first falling edge of CLK after its assertion. The internal divider flip–flops will maintain their state during the freeze. When \overline{EN} is deasserted (LOW), and after the next falling edge of CLK, then the internal divider flip–flops will "unfreeze" and continue to their next state count with proper phase relationships.



Figure 3. Reset Recovery Time





Resource Reference of Application Notes

- AN1404 ECLinPS Circuit Performance at Non–Standard V_{IH} Levels
- AN1405 ECL Clock Distribution Techniques
- AN1406 Designing with PECL (ECL at +5.0 V)
- AN1504 Metastability and the ECLinPS Family
- AN1568 Interfacing Between LVDS and ECL
- AN1650 Using Wire–OR Ties in ECLinPS Designs
- AN1672 The ECL Translator Guide
- AND8001 Odd Number Counters Design
- AND8002 Marking and Date Codes
- AND8009 ECLinPS Plus Spice I/O Model Kit
- AND8020 Termination of ECL Logic Devices

For an updated list of Application Notes, please see our website at http://onsemi.com.

PACKAGE DIMENSIONS

SO-16 **D SUFFIX** CASE 751B-05 **ISSUE J**



NOTES:

- NOTES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	9.80	10.00	0.386	0.393
В	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27	BSC	0.050) BSC
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
М	0 °	7°	0 °	7°
Р	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

PACKAGE DIMENSIONS

TSSOP-16 DT SUFFIX CASE 948F-01 ISSUE O



- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.

- 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
 5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
 6. TERMINAL NUMBERS ARE SHOWN FOR
- 6. TERMINAL NUMBERS ARE SHOWN FOR
- REFERENCE ONLY.
 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INC	иге		
			INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	4.90	5.10	0.193	0.200		
В	4.30	4.50	0.169	0.177		
С		1.20		0.047		
D	0.05	0.15	0.002	0.006		
F	0.50	0.75	0.020	0.030		
G	0.65	BSC	0.026 BSC			
Н	0.18	0.28	0.007	0.011		
J	0.09	0.20	0.004	0.008		
J1	0.09	0.16	0.004	0.006		
K	0.19	0.30	0.007	0.012		
K1	0.19	0.25	0.007	0.010		
L	6.40		0.252 BSC			
М	0 °	8°	0°	8°		

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